MPSH17

Preferred Device

CATV Transistor

NPN Silicon

Features

• Pb-Free Package is Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V _{CEO}	15	Vdc
Collector - Base Voltage	V _{CBO}	20	Vdc
Emitter – Base Voltage	V _{EBO}	3.0	Vdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	350 2.81	mW mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

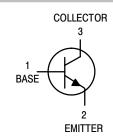
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (Printed Circuit Board Mounting)	$R_{\theta JA}$	357	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

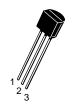


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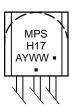
http://onsemi.com



MARKING DIAGRAM



TO-92 CASE 29-11 STYLE 2



MPSH17 = Device Code A = Assembly Location

Y = Year
WW = Work Week
■ Pb-Free Package
(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MPSH17	TO-92	5,000 Units/Box
MPSH17G	TO-92 (Pb-Free)	5,000 Units/Box
MPSH17RLRA	TO-92	2,000/Tape & Reel
MPSH17RLRAG	TO-92 (Pb-Free)	2,000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MPSH17

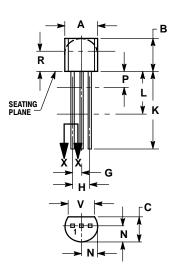
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

				i
V _{(BR)CEO}	15	_	_	Vdc
V _{(BR)CBO}	20	_	_	Vdc
V _{(BR)EBO}	3.0	_	_	Vdc
I _{CBO}	-	_	100	nAdc
•	•			
h _{FE}	25	_	250	_
V _{CE(sat)}	-	_	0.5	_
1	•	•	•	
f _T	800	_	_	MHz
C _{cb}	0.3	_	0.9	pF
h _{fe}	30	-	_	_
NF	_	_	6.0	dB
G _{pe}	-	24	_	dB
	V(BR)CBO V(BR)EBO ICBO hFE VCE(sat) fT Ccb hfe NF	V(BR)CBO 20 V(BR)EBO 3.0 ICBO - hFE 25 VCE(sat) - fT 800 Ccb 0.3 hfe 30 NF -	V(BR)CBO 20 - V(BR)EBO 3.0 - ICBO hFE 25 - VCE(sat) f _T 800 - C _{cb} 0.3 - hfe 30 - NF	V(BR)CBO 20 - - V(BR)EBO 3.0 - - ICBO - - 100 hFE 25 - 250 VCE(sat) - - 0.5 fT 800 - - Ccb 0.3 - 0.9 hfe 30 - - NF - - 6.0

MPSH17

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 114-3M, 1902.
 CONTROLLING DIMENSION: INCH.
 CONTOUR OF PACKAGE BEYOND DIMENSION R
 IS UNCONTROLLED.
 LEAD DIMENSION IS UNCONTROLLED IN P AND
- BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
v	0 135		3 43	

STYLE 2:

- PIN 1. BASE
 - 2. EMITTER 3. COLLECTOR

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